FORM PTO-1595 (Modified)

05-16-2001



Docket No.: SEC.803

U.S. DEPARTMENT OF COMMERCE

(Rev. 6-93) OMB No. 0651-0011 (exp.4/94) Copyright 1996-97 LegalStar P08A/REV02	Patent and Trademark Office
Tab settings → → ▼	7564 ▼ ▼
To the Honorable Commissioner of Patents and Trademark	s: Please record the attached original documents or copy thereof.
1. Name of conveying party(ies): KIM, Dong-Sik	2. Name and address of receiving party(ies):
PARK, Cheoul-Su	Name: SAMSUNG ELECTRONICS CO., LTD.
	Address: 416, Maetan-dong, Paldal-gu,
Additional names(s) of conveying party(ies)	
3. Nature of conveyance:	
	j.
☐ Security Agreement ☐ Change of Name	City: Suwon-city, Kyungki-do State/Prov.:
☐ Other	Country: Republic of Korea ZIP:
Execution Date: April 18, 2001	Additional name(s) & address(es)
Patent Application No. Filing date NEW MAY 9, 2001	B. Patent No.(s)
Additional number	rs Yes 🛛 Yo
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: ADAM C. VOLENTINE	7. Total fee (37 CFR 3.41):\$ 40.00
Registration No. 33289	Enclosed - Any excess or insufficiency should be credited or debited to deposit account
Address: JONES VOLENTINE, PLLC	— Credited of debited to deposit account
12200 SUNRISE VALLEY DRIVE, SUITE 150	☐ Authorized to be charged to deposit account
City: RESTON State/Prov.: VA Country: U.S.A. ZIP: 20191	8. Deposit account number: 50-0238
FC:581 40.00 DP 9. Statement and signature.	or USE THIS SPACE

To the best of my knowledge and belief, the foregoing informati of the original document.

ADAM C. VOLENTINE

Signature

Date

MAY 9, 2001

Name of Person Signing

Total number of pages including cover sheet, attachments, and

J O N E S VOLENTINE L.L.C. (1/2001)

ASSIGNMENT

Insert Name(s) of Inventor(s)	In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned KIM, Dong-Sik PARK, Cheol-Su
	and
Insert Name(s) of Assignee(s)	the undersigned hereby sell(s) and assign(s) to SAMSUNG ELECTRONICS CO., LTD.
Address	of 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea
777.4	(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as
Title of Invention	APPARATUS AND METHOD FOR MEASURING WAFER CLAMPING TENSION
Date of Signing of Application	for which an application for patent in the United States of America has been executed by the undersigned on April 18, 2001
	The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
	The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.
	The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
	The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
	The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.
	Page 1 of 2

in witness whereof	executed by the undersion	gned on the date(s) opposite th	ne undersigned name(s)
Date Tiphex 18, 200	/, Name of Inventor	Dong-Sik KIM	
Date April 18, 20	Name of Inventor	Dong-Sik KIM Cheel-Su PARK Cheel-Su PARK	
		Cheoi-su PARK	
Date	, Name of Inventor		
least two witnesses van Assignment even Witness	who sign here. However, t if it has not been acknowl	the current practice of the U.S.	
This	day of	, 19	_, before me personally came the above-
named			
to me personally known as th			who did acknowledge to me that he (they)
	_		
executed the same of his (the		Official Signat	ure
executed the same of his (the		Official Signat	ure
executed the same of his (the		Official Signat	ure
executed the same of his (the	*****	Official Title	ure . * * * * * * * * * * * * * * * * * * *
executed the same of his (the SEAL * * * * * * * * * * * * * * * * * * *		Official Title * ** * * * * * * * * * * * * * * * *	

RECORDED: 05/09/2001

The undersigned hereby grant(s) to Adam C. Volentine, Reg. No. 33,289, and the firm of JONES VOLENTINE,

PATENT REEL: 011789 FRAME: 0833